



Original Research

# Design and Implementation of a Discrete-Time Proportional Integral (PI) Controller for the Temperature Control of a Heating Pad

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#### **Abstract**

Contact heat evoked potentials (CHEPs) are recorded from the brain by giving thermal stimulations through heating pads kept on the surface of the skin. CHEP signals have crucial diagnostic implications in human pain activation studies. This work proposes a novel design of a digital proportional integral (PI) controller based on Arduino microcontroller with a view to explore the suitability of an electric heating pad for use as a thermode in a custom-made, cost-effective CHEP stimulator. The purpose of PI controller is to set, regulate, and deliver desired temperatures on the surface of the heating pad in a user-defined pattern. The transfer function of the heating system has been deduced using the parametric system identification method, and the design parameters of the controller have been identified using the root locus technique. The efficiency of the proposed PI controller in circumventing the well-known integrator windup problem (error in the integral term builds excessively, leading to large transients in the controller output) in tracking the reference input and the controller effort (CE) in rejecting output disturbances to maintain the set temperature of the heating pad have been found to be superior compared with the conventional PI controller and two of the existing anti-windup models.

### **Keywords**

PI controller, Arduino microcontroller, CHEPS, system identification

### Introduction

Thermal stimulation of the sensory nerve fibers on the skin surface elicits electric potentials in the brain, known as contact heat evoked potentials (CHEPs),1,2 which could be recorded in electroencephalograms (EEGs). Similar to the study of any other evoked responses (auditory, visual, and somatosensory) recorded in EEGs, the heat stimuli are presented in a repetitive fashion to subjects in order to use the conventional trigger locked averaging procedure3,4 to extract the CHEP associated with the presentation of the thermal stimulus by significantly suppressing uncorrelated noise, which is inevitably present in the measured EEG data. The study of CHEP signals is essential to understand the level of mediation of the nociceptive receptors of the sensory neurons in responding to the pain stimulus in a variety of neurological dysfunctions, including neuropathy. 1,2,5-7 Typically, temperatures of the order of 50 °C are used to present a thermal stimulus on the skin surface using either a fast-acting heat foil thermode<sup>1,2,5-7</sup> or a laser pointer<sup>8,9</sup> in CHEP stimulators. Regulation of the current passing through the thermode (the heating element) using a control mechanism is necessary to engineer the CHEP stimulator for safe practical use.

Commercial CHEP stimulators have thermodes with a rapid rising time of 70 °C/s in delivering the stimulus without any delay or heat loss to the skin surface of subjects. These fast time domain specifications of the sophisticated thermode designs allow the CHEP stimulator to deliver the heat as a series of repetitive pulses at a predefined rate dictated by the user-desired interstimulus time interval (ITI), which is the time interval between successive stimuli in any

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stimulus presentation system during a typical evoked response EEG experiment.

However, the ITI for pain studies has been recommended to be set at a slower rate of 0.05–0.1 Hz (i.e., one heat pulse in 10–20 s) to prevent very frequent exposures of the skin surface to heat stimuli, which has the potential to result in cutaneous lesions. Considering the necessity of delivering the heat stimulus at a significantly slower repetition rate irrespective of the fast response time of the thermode, it may be expected that even a movable thermode coupled to a linear actuating shaft (controlled by a motorized mechanism operating at slow speed) might accomplish the task of delivering heat in a pulsed manner as an alternative to the fixed thermode with tunable heat output in commercial CHEP stimulus presentation systems.

As a part of this idea, the present work explores the feasibility of using a simple electric heating pad with slow response time as a thermode in a CHEP stimulator. A comprehensive analysis has been performed to understand the output characteristics of the heating pad, and based on this analysis, a suitable digital proportional integral (PI) control system has been designed for controlling its heat output. Taking into account the limitation in the thermal dynamics of this heating pad (with an intrinsic slow heating rate), the proposed system design attempts to optimize the performance of the CHEP stimulator by meeting the following two essential specifications of the heat control system:

- 1. The settling time  $(T_s)$  of the control system for unit step input should be at most 4 s to track the desired temperatures at the surface of the heating pad.
- 2. In the presence of environmental effects, the heating pad is likely to lose its surface temperature (typically 1–2 °C) and is exposed to short-term temperature fluctuations due to external disturbances and intermittent contact with the skin surface; the controller effort (CE), which is associated with the ability of the controller to reject these disturbances, should therefore be designed to be fast enough in correcting the temperature to the set value within ITI (typically 15 s).

The control system design described in this article justifies the suitability of the heating pad for use in a CHEP stimulator by highlighting two important improvements that have been incorporated in the design to stabilize the user-desired set temperature. First, an anti-windup structure that limits the overshoot in the settling time of the temperature of the heating pad has been incorporated, and second, the design of the CE has been improved. The incorporation of both improvements in the proposed control system has yielded performance that is superior to that obtained using a conventional PI controller, and two popular anti-windup models described in the literature.

### **Materials and Methods**

An electric heating pad (SparkFun Electronics, Niwot, CO) constructed out of a mesh of polyester filament and micrometal conductive fibers folded into a protective polyimide film with a resistance of  $8.5\Omega$  is used in the present work. An N-Channel MOSFET P55NF06 (STMicroelectronics, Geneva, Switzerland) is used as an actuator to supply variable current to control the temperature of the heating pad. The PI controller is realized using an Arduino Mega 2560 microcontroller. 10 This microcontroller can receive an 8-bit pulse width modulation (PWM) signal at its pins, which is used to generate a corresponding variable analog voltage to control the heating current. To measure the temperature of the heating pad, a commercially available analog temperature sensor, namely, LM35 (Texas Instruments, Dallas, TX), having a precision of 0.5 °C, is used in this work. The parameters, such as settling time, rise time, and steadystate errors, were assessed at the output of the controller considering the conventional definitions of each of the control parameters as used in the standard control system literature. 11,12

The design of the control system for the heating pad involves the following steps:

- System identification: Identifying the first-order and second-order transfer functions of the heating pad by measuring its output characteristics.
- Design of a PI controller and anti-windup structure:
   Designing the system parameters to meet the time domain specifications of the identified system by using the root locus pole estimation method.
- Digital realization and implementation of the PI control system with an anti-windup structure to control the temperature of the heating pad using the microcontroller.

Each of these steps is explained in the subsequent sections under major and minor subheadings.

# System Identification: Electric Heating Pad

To precisely control a process, a mathematical model that represents the dynamic behavior of the system is essential. 11–14 However, due to the complexity involved in obtaining the mathematical model of the heating pad by physical—mathematical analysis, the parametric system identification method has been used in this work by measuring the input—output characteristics. A standard system model has been fitted to the measured characteristics of the system to estimate the model parameters.

The output characteristics of the heating pad are obtained by passing a step current of 0.5 A, which is equal to

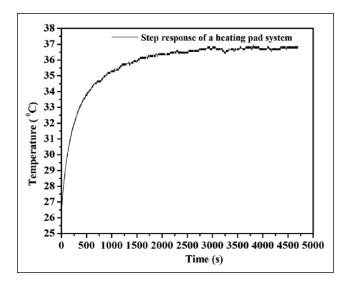


Figure 1. Measured step response of the heating pad system.

one-third of its rated current (at 12 V DC supply), through the heating pad, and the temperature response is recorded for 80 min. The inevitable miniscule time delay in the rise of the step current from 0 to 0.5 A of the power supply is neglected in the system identification calculations. **Figure 1** shows the measured open-loop response of the heating pad to the applied step input. From this measured step response, the step-response curve method<sup>13</sup> is used to get the approximated first-order transfer function, and the algebraic method<sup>15</sup> is used to get the approximated second-order transfer function of the heating pad.

### First-Order System Identification

Taking y(t) and u(t) as output and input, the transfer function G(s) of a first-order system is given by

$$G(s) = \frac{Y(s)}{U(s)} = \frac{K}{Ts+1} \tag{1}$$

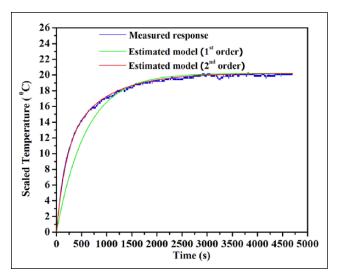
where *K* and *T* are the open-loop gain and the time constant of the system, respectively.

The Laplace transform of the output is given by

$$Y(s) = G(s)U(s)$$
 (2)

where  $U(s) = \frac{A}{s}$  is the Laplace transform of the step input with amplitude A.

Since the initial value of the step response is nonzero (as shown in **Fig. 1**), it is shifted to the origin by a value of  $y_0 = -26.64$ , and the output values are normalized to obtain the response for the unit step input amplitude (as shown in **Fig. 2**, blue color plot).



**Figure 2.** Step responses of the measured system (blue), estimated first-order model (green), and estimated second-order model (red) of the heating pad system.

According to final value theorem, we have

$$y(\infty) = \lim_{s \to 0} s Y(s) = KA \tag{3}$$

The value of K calculated from eq 3 is 20.2.

After applying inverse Laplace transforms to eq 2, it reduces to

$$y(t) = -KAe^{-t/T} + KA \tag{4}$$

For calculating the time constant (T), coordinates of any two points (t1, y(t1)) and (t2, y(t2)) located above and below the point of inflection of the step-response curve are substituted into eq 4 to evaluate the time constant T:

$$T = \frac{t2 - t1}{\ln\left(\frac{y(t1) - KA}{y(t2) - KA}\right)}$$

We have taken 10 sets of coordinates above and below the inflection point and averaged the obtained time constants to get the optimum time constant  $T_{optimum}$ :

$$T_{optimum} = \frac{T_1 + T_2 \dots + T_{10}}{10} = 586$$

By substituting the open-loop gain and time constant values into eq 1, the estimated first-order transfer function of the electric heating pad system G(s) is obtained as given below.

$$G(s) = \frac{20.2}{586s + 1}$$

The step responses of the measured and estimated firstorder transfer functions are given by G(s) and G(s), respectively, and are plotted as shown in Figure 2 (blue and green color plots, respectively)

To quantitatively evaluate the goodness of fit of the estimated model, the normalized mean square error (NMSE) is calculated:

$$NMSE = 1 - \frac{y_{measured} - y_{model}^{2}}{y_{measured} - mean(y_{measured})^{2}}$$
 (5)

where  $y_{measured}$  and  $y_{model}$  are step responses of the measured and estimated systems, and y indicates norm-2 of vector y. The NMSE value varies between  $-\infty$  (bad fit) and 1 (perfect fit).

NMSE for the estimated first-order model is 0.8992, indicating a reasonably good fit, which can be further improved using a second-order transfer function as a possible model.

### Second-Order System Identification

The detailed procedure for identifying the second-order transfer function can be found elsewhere. 15 Here we give the final expression for the second-order transfer function as

$$G(s) = \frac{K(T_3 s + 1)}{(T_1 s + 1)(T_2 s + 1)}$$
where  $T_1 < T_2 & T_3 \neq T_1 \neq T_2$  (6)

where K is the open-loop gain and  $T_1, T_2, T_3$  are the time constants of the system.

The open-loop gain (K) of the system is calculated to be 20.2 by following a procedure similar to that used for estimating the first-order transfer function for the system.

After applying inverse Laplace transforms to eq 2, it reduces to

$$y(t) = KA \left[ 1 + \frac{T_3 - T_1}{T_1 - T_2} e^{-t/T_1} - \frac{T_3 - T_2}{T_1 - T_2} e^{-t/T_2} \right]$$
 (7)

Taking three different points from step response  $(t_1, y(t_1))$ ,  $(2t_1, y(2t_1))(3t_1, y(3t_1))$  and substituting those points into eq 7, three different equations (eqs 8–10) are obtained:

$$y(t_1) = KA \left[ 1 + \beta \alpha_1 - (1 + \beta) \alpha_2 \right]$$
 (8)

$$y(2t_1) = KA \left[ 1 + \beta \alpha_1^2 - (1+\beta)\alpha_2^2 \right]$$
 (9)

$$y(3t_1) = KA \left[ 1 + \beta \alpha_1^3 - (1+\beta) \alpha_2^3 \right]$$
 (10)

where

$$\alpha_1 = e^{-t_1/T_1} \tag{11}$$

$$\alpha_2 = e^{-t_1/T_2} \tag{12}$$

$$\beta = \frac{T_3 - T_1}{T_1 - T_2} \tag{13}$$

From eqs 8-10, assume

$$K_1 = \frac{y(t_1)}{KA} - 1 \tag{14}$$

$$K_2 = \frac{y(2t_1)}{KA} - 1 \tag{15}$$

$$K_3 = \frac{y(3t_1)}{KA} - 1 \tag{16}$$

With this notation, egs 8-10 may be substituted to determine the three unknowns,  $\alpha_1, \alpha_2$ , and  $\beta$ :

$$\alpha_1 = \frac{K_1 K_2 + K_3 - \sqrt{b}}{2(K_1^2 + K_2)} \tag{17}$$

$$\alpha_2 = \frac{K_1 K_2 + K_3 + \sqrt{b}}{2(K_1^2 + K_2)} \tag{18}$$

$$\beta = \frac{2K_1^3 + 3K_1K_2 + K_3 - \sqrt{b}}{\sqrt{b}} \tag{19}$$

where 
$$b = 4K_1^3K_3 - 3K_1^2K_2^2 - 4K_2^3 + K_3^2 + 6K_1K_2K_3$$

The time constants of the system are calculated by substituting the values of  $\alpha_1$ ,  $\alpha_2$ , and  $\beta$  into eqs 11–13:

$$T_1 = \frac{-t_1}{\ln(\alpha_1)} = 812$$

$$T_2 = \frac{-t_1}{\ln(\alpha_2)} = 180$$

$$T_3 = \beta(T_1 - T_2) + T_1 = 500$$

We have taken 100 sets of coordinates over the measured response (origin shifted and normalized) and averaged the obtained time constants  $(T_1, T_2, T_3)$  to get the optimum time constants ( $T_1$  optimum,  $T_2$  optimum,  $T_3$  optimum):

$$T_{1\_optimum} = \frac{T_1^1 + T_1^2 + \dots + T_1^{100}}{100} = 812$$

$$T_{2\_optimum} = \frac{T_2^1 + T_2^2 + \dots + T_2^{100}}{100} = 180$$

$$T_{3\_optimum} = \frac{T_3^1 + T_3^2 + \dots + T_3^{100}}{100} = 500$$

By substituting the open-loop gain and time constants into eq 6, the estimated second-order transfer function of the electric heating pad system is given as follows:

$$G(s) = \frac{20.2(500s+1)}{(812s+1)(180s+1)}$$

The step responses of G(s) and G(s) are shown in **Figure 2** (blue and red color plots, respectively).

The NMSE, as defined in eq 5, is calculated to be 0.9967 for the second-order system. Hence, it is evident that the output response of the heating pad closely resembles that of a second-order system.

### **Discrete PI Controller Design**

# Estimation of PI Controller Parameters Using Root Locus-Based Pole Placement Technique

The placement of the poles of a closed-loop system could be tailored to meet the desired time domain specifications using the root locus pole placement technique. A detailed description of this technique may be found in the literature. <sup>16,17</sup> Using this technique, the dominant complex conjugate poles corresponding to the envisaged time domain specifications (settling time of 4 s for unit step input and damping ratio of 0.8) for the heating pad are  $S_d = -1 \pm j0.75$ .

The intrinsic heating rate of the heat pad is found to be 0.5 °C/s by passing maximum rated current through it. We chose a settling time of 4 s for a rise in temperature of 1 °C from room temperature (~25 °C). The choice of damping ratio is in general a trade-off between the maximum percent overshoot and the time at which the peak overshoot occurs. The optimal choice of damping ratio has been extensively evaluated for its suitability for the present work and has been found to be 0.8.

The open-loop transfer function of uncompensated system is given by

$$G(s) = \frac{0.0701(s+0.002)}{(s+0.0012)(s+0.0056)}$$

The general form of the transfer function of the PI controller is given by

$$G_{PI}(s) = K_P + \frac{K_I}{s} = \frac{K(s + Z_c)}{s}$$
 (20)

where  $Z_c$  is the location of zero for the PI controller.

The open-loop transfer function of the compensated system is given by

$$G_{Comp\_openloop}(s) = G_{Pl}(s)G(s)$$

$$= \frac{K*0.0701*(s+Z_c)(s+0.002)}{s(s+0.0012)(s+0.0056)}$$

$$G_{Comp\_openloop}(s) = \frac{K'(s+Z_c)(s+0.002)}{s(s+0.0012)(s+0.0056)}$$

where K' = K \* 0.0701.

To obtain the desired parameters for the PI controller, the root locus plot of the system has been shifted to pass the desired complex conjugate poles  $S_d$ . The appropriate value for  $Z_c$  has been found to be 0.7831, and the value of the open-loop gain at  $S_d$  has been calculated to be K'=2 using the root locus angle criterion. <sup>16,17</sup>

Therefore, the value of the PI controller gain is K = K'/0.0701 = 28.46.

The transfer function of the PI controller is  $G_{PI}(s) = 28.46 * \frac{s + 0.7831}{s}$ .

From the above transfer function of the PI controller, the corresponding proportional and integral parameters are obtained by comparing with eq 20;  $K_P = 28.46$ ;  $K_I = 22.28$  are obtained.

The closed-loop transfer function of the compensated system is given by

$$G_{Comp\_closedloop}(s) = \frac{G_{PI}(s)G(s)}{1 + G_{PI}(s)G(s)}$$
$$= \frac{2(s + 0.7831)(s + 0.002)}{(s + 0.002)(s^2 + 2s + 1.563)}$$

The closed-loop poles and zeros of the compensated system are given by

$$\lambda_{1c} = -0.002$$
,  $\lambda_{2c/3c} = -1 \pm j0.75$ , and  $z_{1c} = -0.002$ 

The effect of the dominant pole  $\lambda_{1c}$  on the transient response of the system will be canceled by the zero ( $z_{1c}$ ) of the system. Therefore, the dominant poles of the compensated system are  $\lambda_{2c,3c}$ , which are same as the desired dominant complex conjugate poles  $S_d$ .

With the obtained values of  $K_P$  and  $K_I$ , simulation studies have been done on the compensated system with the unit step input. The settling time of the system was found to be 4 s.

**Figure 3a,b** shows the schematic and the actual photograph of the designed PI control system for the heating pad. The PI controller with proportional and integral blocks that are realized using an Arduino microcontroller, the N-channel MOSFET that acts as an actuator for the heating pad, and the temperature sensor that measures the actual temperature

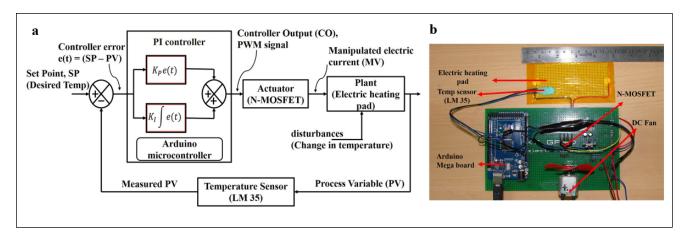


Figure 3. (a) Block diagram of heating pad temperature control system. (b) Practical realization of the PI controller using an Arduino microcontroller.

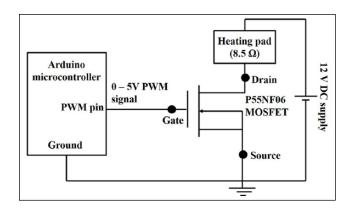
of the heating pad are illustrated schematically in **Figure 3a**. A DC fan is used to avoid overheating of the MOSFET, as shown in **Figure 3b**.

Figure 4 shows the block diagram of the control logic of the MOSFET actuator, which is configured to operate in common-source mode to regulate the temperature of the heating pad. The output of the PI controller algorithm is mapped to the PWM pin of the microcontroller. The 8-bit PWM pins of this microcontroller can generate analog voltages in the range of 0–5 V in proportion to the digital values at these pins (0–255), similar to a digital-to-analog converter (DAC), and the resulting analog voltage from the PWM pin is fed to the gate terminal of the MOSFET. Since MOSFET is a voltage-controlled current output device, the resulting drain current passes through the heating pad.

## Proposed Anti-Windup Structure for the Pl Controller

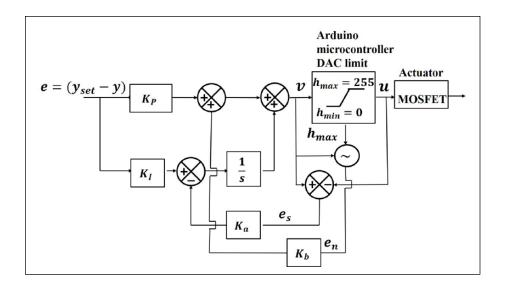
When the control system operates over a wide range of conditions beyond the expected range 0–255 (the DAC limit of the PWM pins), the system output tends to saturate and will be forced to operate in the open-loop mode. The integral term and controller output may then become very large. The control signal (saturated controller output) will then remain saturated even when the error signal (difference between desired output and set point) changes sign, and it may take a considerably long time before the integrator and the controller output come within the saturation range. This would lead to large transients at the output of the controller, causing momentary excursions in the output of the element that is to be controlled. In control system design, this situation is commonly referred to as integrator windup. 18,19

**Figure 5** shows the block diagram of the proposed antiwindup structure. The system has an extra feedback path



**Figure 4.** Block diagram of current control logic in heating pad temperature control system.

that generates an error signal  $e_s$ , the difference between the desired controller output (v) and the saturated controller output (u). The signal  $e_s$  is fed to the input of the integrator block. The signal  $e_s$  is zero when there is no saturation and the extra feedback loop has no effect on the system. When the actuator saturates, the amount of error,  $e_s$ , will be subtracted from the integral term. This implies that the controller output is kept close to the saturation limit. The value of feedback gain  $K_a$  is taken as unity. An extra feedback path generates an error signal  $e_n$ , the difference between the controller output (v) and the maximum of the DAC limit  $(h_{max})$ . The signal  $e_n$  is fed to the input of the proportional block. During the process of disturbance rejection, the signal  $e_n$ accelerates the proportional term, ensuring quick action of the controller on the disturbed system. The value of feedback gain  $K_b$  directly influences the effect of signal  $e_n$  on the overall performance of the controller. By taking different values of  $K_b$  (in the range of 0–1), the appropriate value is found to be 0.5 by testing the effect of each value assigned to  $K_b$  on the performance of the controller.



**Figure 5.** Block diagram of the proposed anti-windup structure.

# Digital Representation of the PI Controller with the Proposed Anti-Windup Structure

The parallel form of the PI controller is given by

$$u(t) = K_P e(t) + K_I \int_0^t e(\tau) d\tau$$
 (21)

where the error e(t) is the difference between the reference input and system output, u(t) is the controller output, and  $K_P$  and  $K_I$  are the proportional and integral constants, respectively.

The proportional controller term in discretized form is given by

$$U_{P}(k) = K_{P} * e(k) \tag{22}$$

With the proposed anti-windup structure, eq 22 reduces to

$$U_{P}(k) = (K_{P} * e(k)) + (K_{h} * e_{n}(k-1))$$
 (23)

The integral part in eq 21 is discretized using the trapezoidal rule of integration and is given by

$$\int_{0}^{k^{*}T_{s}} K_{I} * e(t) dt = U_{I}(k) \cong U_{I}(k-1)$$

$$+ K_{I} * \frac{e(k) + e(k-1)}{2} * T_{s}$$
(24)

where  $T_s$  is the update time (sampling rate) of the controller loop.

Since the heating pad system is a very slow process, eq 24 can be approximated as

$$U_I(k) \cong U_I(k-1) + K_I * e(k) * T_s$$
 (25)

With the proposed anti-windup structure, eq 25 reduces to

$$U_{I}(k) = U_{I}(k-1) + (((K_{I} * e(k)) - e_{s}(k-1)) * T_{s})$$
 (26)

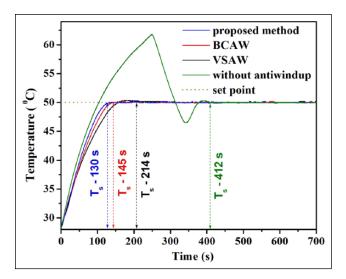
The discrete form of the PI controller with the proposed anti-windup structure is given by

$$U_{PI}(k) = (K_P * e(k)) + (K_b * e_n(k-1)) + U_I(k-1) + (((K_I * e(k)) - e_s(k-1)) * T_s)$$
(27)

Equation 27 represents the discrete form of the PI controller along with the anti-windup feature realized in the integrated development environment (IDE) of the Arduino microcontroller. The PI controller algorithm utilizes the past and present values of the error signal of the controller, along with the loop gains of the proportional and integral terms executed at each sampling instant of the control loop, to track the user-desired set temperature of the heating pad, as illustrated in **Figure 5**.

#### **Results and Discussion**

The working of the proposed PI controller was demonstrated by using it to track a user set temperature of 50 °C (as in a typical CHEP stimulator<sup>1,2,5–7</sup>) over the heating pad. The performance of the proposed system was also compared with that of a conventional PI control system without any anti-windup structure, a PI with back-calculation anti-windup<sup>20</sup> (BCAW), and another with variable structure anti-windup<sup>21</sup> (VSAW). These anti-windup structures were also designed to achieve time domain parameters similar to those of the proposed PI control system to match the output characteristics of the heating pad. **Figure 6** shows the output temperature of the heating pad controlled by the different types of PI controller systems investigated in this study.



**Figure 6.** Reference tracking capabilities of proposed method (blue), PI with BCAW (red), PI with VSAW (black), and conventional PI controller (green).

As seen from **Figure 6**, the settling time of the proposed PI control system is 130 s, which represents a significant improvement in the response of the heating pad compared with the conventional PI controller and two of the existing anti-windup models. It is evident from the **Figure 6** that each PI control system investigated in this study achieves some improvement in the settling time, but each design yields a slightly different settling time. However, the conventional PI controller (without anti-windup) achieves a stabilization in the set temperature with a large overshoot, causing the settling time to be as high as 412 s, and makes the system difficult to use for practical applications. This conspicuous overshoot in the temperature also justifies the necessity of incorporating the anti-windup structure in the PI control system. As expected, the two conventional antiwindup models, namely, the PI with BCAW and the PI with VSAW, exhibit reasonably stable output responses without overshoots. Out of the two anti-windup models, the BCAW shows a settling time of 145 s, which is slightly higher than that provided by the proposed PI system, which incorporates a novel anti-windup feature, reported here for the first time. Figure 7 shows the temperature of the heating pad during a deliberate effort to disturb the temperature output of the heating pad to check the effort taken by the controller in quickly responding to such transient disturbances. A disturbance of the order of 2 °C was applied uniformly to each of the PI control systems after establishing a constant temperature of 50°C at the heating pad. Figure 7 shows the responses of each of the controllers to external disturbance with the coordinates of the disturbance marked on the output graphs. It may be noted from Figure 7 that the proposed controller is capable of rejecting the 2°C disturbance in 9 s and outperforms the conventional PI, PI with

VSAW, and PI with BCAW, as they take 15, 14, and 12 s, respectively, to reject the disturbance and bring the heating pad back to the set temperature. Minor overshoots are found in all the PI systems before settling. These overshoots also occur for a very short time in the proposed system compared with the other PI systems investigated in this study. The small (and hardly visible) fluctuations observed in the output temperature of all the PI systems after reaching the steady state may be attributed to the intrinsic noise of the temperature sensor and the quantization error of the analog-to-digital converter in the Arduino microcontroller. The performance parameters of the different controllers investigated in this study are listed in Table 1 and clearly highlight the superiority of the proposed PI controller over the other conventional PI controllers with respect to settling time, rise time (time required to reach a final value by an underdamped time response signal during its first cycle of oscillation), steady-state error, and the CE in rejecting the external disturbances.

A general inference from the performance analysis of this control system design is that even though the heating element is intrinsically slow in response, the required time domain parameters could be engineered by designing an appropriate control system. The present work demonstrates that the PI controller with the proposed anti-windup structure serves the purpose of overcoming the intrinsic limitations of the heating pad and ensures that the design will be useful for any practical purpose of providing a stable working temperature. Very often, a proportional integral derivative (PID) controller<sup>16,17</sup> has been used by control engineers for similar purposes of temperature regulation. As the heating rate of the heating pad used in this work is 0.5 °C/s and hence for a system with such a slow response time—the derivative term in the PID controller is not regarded as essential.

In each step of the design reported in the present work, starting from system identification, deducing the secondorder transfer function, and designing the control parameters for PI, the design is aimed at achieving the desired time domain specifications in stabilizing the temperature output of the heating pad, taking into account its experimentally measured heating characteristic, by using a proper choice of P and I parameters, as well as by designing an appropriate anti-windup structure. As evidenced in the performance evaluation, when the proposed system is operated after it has reached the steady-state temperature desired by the user, the system is stable and relatively unaffected by small environmental disturbances. Its ability to quickly come back to the stable temperature regime even in the presence of inevitable external disturbances is remarkable. Hence, it may be expected that the proposed control system is ideally suited for using the heating pad as a thermode in a CHEP stimulator, especially in situations where the heating pad makes and breaks contact with the skin of the subjects at repetitive

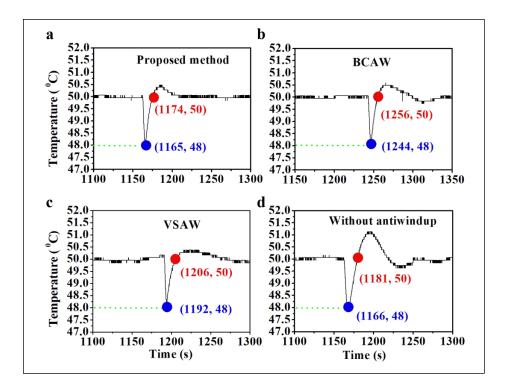


Figure 7. Output disturbance rejection capability of the controller: (a) proposed method, (b) PI with BCAW, (c) PI with VSAW, and (d) conventional PI without anti-windup.

Table 1. Performance Parameters of Different PI Controllers.

Method	Performance Parameters		
	Rise Time (s)	Settling Time (s)	Time Taken by Controller to Reject 2 °C Disturbance (s)
Proposed method	88	130	9
PI with BCAW	112	145	12
PI with VSAW	115	214	14
Conventional PI (without anti-windup)	78	412	15

intervals, which might cause momentary instabilities in the output temperature. Indeed, one of the essential requirements of the heat control system in this context is the ability of the controller in correcting such temperature fluctuations, if any, within the period of presentation of the next heat stimulus as dictated by the ITI ( $\sim$ 10–20 s). The ability of the proposed system in handling this anticipated issue through fast rise and settling times, as well as CE, makes it useful for developing a custom-made CHEP stimulator design based on the novel PI controller with an anti-windup structure proposed in this work for conducting heat stimulus experiments in EEG. Besides, the realization of the control system in the digital domain makes it more user friendly by enabling a quick change in the values of various design parameters to suit varying needs that arise in the context of different applications. In EEG recordings with a commercial CHEP stimulator, the thermode will always be in contact with the skin, which might activate non-nociceptive fibers, and these non-nociceptive inputs might fall in CHEP origin. But, in the case of the proposed CHEP stimulator, as the thermode makes and breaks contact with the skin at regular intervals, the chance of activation of non-nociceptive fibers is likely to be less than that of a commercial CHEP system. This can be considered one of the major advantages of the proposed CHEP system. In addition, the cost involved in the development of the proposed CHEP system is nearly US\$100, which is much cheaper compared with a commercial system. The structure of the proposed CHEP system is simple and can be easily developed.

In summary, the discrete PI controller design presented here meets all the desired performance specifications, including the critical time domain specifications, such as reference tracking the set temperature and output disturbance rejection as envisaged by the user, especially in the context of a CHEP stimulator, and ensures a stable control of desired temperature as required in a number of applications.

### Conclusion

We have presented a detailed design of a cost-effective PI control system with anti-windup to precisely set and maintain the temperature of a heating pad with reasonable response time, meeting the technical requirements of the CHEP stimulators. A detailed analysis of each of the constituent modules of the control system has been carried out, and by practically realizing the system, we have successfully demonstrated its performance. The proposed control system has been found to be suitable for designing a CHEP stimulator for neurological investigations.

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